Daniel Lim

Ph.D., Department of Mechanical Engineering
University of California, Berkeley, USA
Phone: +1-341-766-9018 Email: limdan7@berkeley.edu

Website: https://dahyundaniellim.com/

megos, admy distalled miscons		
RESEARCH FIELDS	Data-driven mechanical design and manufacturing Machine learning-based design, 3D-printing, Finite element analysis	
EDUCATION	Ph.D. in Mechanical Engineering	2024. 08
	Advisor: Prof. Grace X. Gu	
	University of California, Berkeley	
	M.S in Mechanical Engineering	2018
	Advisor: Prof. Alice M. Agogino	
	University of California, Berkeley	
	M.Eng in Mechanical Engineering	2015
	Advisor: Prof. Alice M. Agogino	
	University of California, Berkeley	
	B.S in Mechanical Engineering	2014
	Korea University, Seoul, Republic of Korea	
WORK	R&D engineer	2020 – 2021
EXPERIENCE	Multiscale Transfer Lab	
	Korea University, Seoul, Republic of Korea	
	Mechanical Design Engineer	2018 – 2019
	The Wave Talk. Inc, Seoul, Republic of Korea	
HONORS	[10] BioEnginuity fellowship	2023
&	[9] International Design Award (IDA) silver	2022
AWARDS	[8] Platinum A' Design award, Italy	2022
	[7] H2H8 Fellowship	2022
	[6] Machine learning driven service using non-verbal sound award, Korea	2021
	[5] Artificial Intelligence driven vehicle exterior service award, Korea	2021
	[4] Outstanding GSI Award, Berkeley, USA	2018
	[3] CITRIS Tech for social goods, Berkeley, USA	2017
	[2] Korea Science and Engineering Full scholarship	2014
	[1] Best Research Award of Creative Challenger Program, Korea	2014

PUBLICATIONS Peer Reviewed Journal

- ‡ Equally contributed
- [12] **Lim. D.D.**; Ibarra. A.I.; Lee. J.; Jung. J.; Choi. W.; Gu. G. X*; " A tunable metamaterial microwave absorber inspired by chameleon's color-changing mechanism", (manuscript in preparation)
- [11] **Lim. D.D.**;; Lee. J.W.;; Park. J.W.; Lee. J.M.; Noh. D.W.; Park. S.J.; Grace. X. Gu.*; Choi. W.*; "Multifunctional seamless meta-sandwich composite as lightweight, load-bearing, and broadband-electromagnetic-wave-absorbing structure", (under review)
- [10] **Lim. D.D.**; Lee. S.R.; Lee. J.H.; Choi. W.*; Grace. X. Gu.*; "Mechanical metamaterials as multifunctional broadband electromagnetic wave absorbers". **Materials Horizons**, 2024
- [9] Lee. S, Sheikh HM, Lim, D. D., Gu, G. X., & Marcus, P. S. (2024). Bayesian-Optimized Riblet Surface Design for Turbulent Drag Reduction via Design-by-Morphing with Large Eddy Simulation. **Journal of Mechanical Design**, 146(8), 081701.

- [8] Wei, Z., Zhang, Z., Lim, D., Rey, J., Jones, M., & Gu, G. X. (2024). Influence of bioinspired riblet topographies on the mitigation of flow-induced noise in towed sonar arrays. Extreme Mechanics Letters, 102130.
- [7] Song, C., Lee, J., **Lim, D. D.**, & Choi, W. (2023). Rationally Tunable Phase Change Material Thermal Properties Enabled by Three-Dimensionally Printed Structural Materials and Carbon-Based Functional Additives. **International Journal of Energy Research**, 2023.
- [6] Lee. J.W.‡, **Lim. D. D.**‡, Park. J.W., Lee. J.M., Noh. D.W., Gu, G. X.*, Choi. W.* (2023); Multifunctionality of additively manufactured Kelvin foam for electromagnetic wave absorption and load bearing, **Small**, 2305005
- [5] Jin, Z., Lim, D. D., Zhao, X., Mamunuru, M., Roham, S., & Gu, G. X. (2023). Machine learning enabled optimization of showerhead design for semiconductor deposition process. **Journal of Intelligent Manufacturing**, 1-11.
- [4] Lee, S., Lim, D. D., Pegg, E., & Gu, G. X. (2022). The origin of high-velocity impact response and damage mechanisms for bioinspired composites. Cell Reports Physical Science, 3(12), 101152.
- [3] Lim. D. D.‡; Park. J.W.‡; Lee. J.M.; Noh. D.W.; Choi. J.H.; Choi. W.*; "Broadband Mechanical Metamaterial Absorber", Additive Manufacturing, 2022, DOI: 10.1016/j.addma.2022.102856
- [2] **Lim. D. D.**‡; Lee. J.M.‡; Park J.W.; Choi. W.*; "High-resolution and electrically conductive three-dimensional printing of carbon nanotube-based polymer composites enabled by solution intercalation", **Carbon, 2022**, DOI: 10.1016/j.carbon.2022.03.042
- [1] Lee. S.J.‡; Lee. H.M.‡; **Lim. D. D.**; Song C.H.; Choi. W.*; "Temperature-responsive ultrasonic-wave engineering using thermoresponsive polymers", **Advanced Functional Materials**, **2021**, 31, 2104042

Conference Proceedings

- [2] **Lim, D.**, Georgiou, T., Bhardwaj, A., O'Connell, G. D., & Agogino, A. M. Customization of a 3D printed prosthetic finger using parametric modeling. **IDETC-CIE**, **2018** (Vol. 51753, p. V02AT03A034). American Society of Mechanical Engineers.
- [1] Schoop, E., Nguyen, M., **Lim, D.**, Savage, V., Follmer, S., & Hartmann, B. Drill Sergeant: Supporting physical construction projects through an ecosystem of augmented tools. In Proceedings of the **2016 CHI Conference** Extended Abstracts on Human Factors in Computing Systems (pp. 1607-1614).

Magazine

[1] "Sophie's Super Hand", Berkeley Engineer cover page, Fall 2015 - Link

Patents

[1] Park, J., Song, J., Jeon, E., Lee, K., Choi, J., <u>Lim, D.</u>, Lee, J., Choi, W. "Electrically Conductive Polymer Composites Manufacturing Method Thereof 3D Printing Method using The Polymer Composites" – KR/PT20210370

WORKSHOPS & PRESENTATION

- [6] <u>Lim, D.</u>, et al. "Design of Showerheads Using Machine Learning for Optimizing Semiconductor Manufacturing Processes" MRS Fall meeting, 2022
- [5] <u>Lim, D.</u>, et al. "Additive Manufacturing of Drag Reducing Synthetic Surfaces Inspired by Shark Denticles, **MRS Spring meeting**, **2022**
- [4] <u>Lim, D.</u>, et al. "Additive Manufacturing of Conductive Polymer Using Stereolithography— Effects of Multi-Walled Carbon Nanotubes Reinforcement on Electrical Properties and Dimensional Accuracy, **MRS Fall meeting**, 2020
- [3] <u>Lim, D.</u>, et al. "3D printing of high resolution and electrically conductive composite using carbon nanotube", KSME 2020
- [2] Lim, D., et al. "Design and Fabrication Methodology for Customizable, Multi-material

Prosthetic Hands for Children" ASME International Design Engineering Technical Conference (IDETC) 2017

[1] <u>Lim, D.</u>, et al. "Million Hands: Make It Yourself prosthetics" **ACMMM 2017 Maker's program presentation**